

40V 3.5mohm N-channel SGT MOSFET
AKG4N035GM-A

Description:

This device is designed for automotive applications and manufactured in IATF16949 certified facilities. Qualified AEC-Q101.

Features:

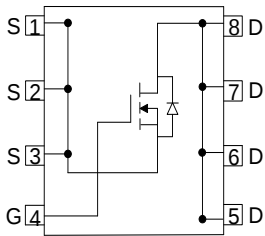
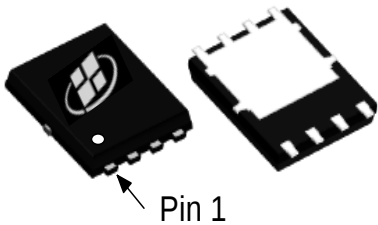
- Low $R_{DS(ON)}$
- 100% UIS Tested
- 175°C Operating Temperature
- RoHS compliant ^(Note 1)
- Halogen-free ^(Note 1)
- AEC-Q101 qualified

Applications:

- Battery Management System
- Motor Drivers

Key Performance Parameters:

Parameter	Value	Unit
V_{DS}	40	V
$R_{DS(ON)}$, max @ $V_{GS} = 10V$	3.5	mΩ
I_D	90	A



Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKG4N035GM-A	PDFN5X6	G4N035GM	Tape Reel	5000PCS

Notes:

1. Contact ALKAIDSEMI sales for detail information

Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	40	V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$) ^(Note 1)	90	A
	Drain Current - Continuous ($T_C = 100^\circ\text{C}$)	63	A
I_{DM}	Drain Current - Pulsed ^(Note 2)	360	A
V_{GS}	Gate-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy ^(Note 3)	144	mJ
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	51	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +175	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	2.9	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady State ^(Note 4)	45	$^\circ\text{C/W}$

Notes:

1. The max drain current rating is package limited
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. $L = 0.5\text{ mH}$, $V_{DD} = 20\text{ V}$, $I_{AS} = 24\text{ A}$, $R_G = 25\ \Omega$, Starting $T_J = 25\ ^\circ\text{C}$
4. Mount on minimum PCB layout

Electrical Characteristics ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 40 V, V _{GS} = 0 V			1	μA
		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 125 °C			100	μA
I _{GSS}	Gate Leakage Current	V _{GS} = ± 20 V, V _{DS} = 0 V			± 100	nA
V _{GS(TH)}	Gate Threshold voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	3	4	V
R _{DS(ON)}	Drain-Source on-state resistance	V _{GS} = 10 V, I _D = 25 A		2.5	3.5	mΩ
Dynamic Characteristics						
C _{ISS}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, F = 1 MHz		1860		pF
C _{OSS}	Output Capacitance			560		pF
C _{RSS}	Reverse Transfer Capacitance			15		pF
R _G	Gate Resistance	F = 1 MHz		2.4		Ω
Switching Characteristics						
T _{D(ON)}	Turn On Delay Time	V _{DD} = 20 V , R _L = 1 Ω, V _{GS} = 10 V, R _G = 6.8 Ω		11		nS
T _R	Rise Time			43		nS
T _{D(OFF)}	Turn Off Delay Time			23		nS
T _F	Fall Time			8		nS
Q _G	Total Gate Charge	V _{DD} = 20 V , I _D = 20 A, V _{GS} = 10 V		22.5		nC
Q _{GS}	Gate-Source Charge			6.5		nC
Q _{GD}	Gate-Drain Charge			4.5		nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Body-Diode Forward Current				90	A
I _{SM}	Maximum Pulsed Body-Diode Forward Current ^(NOTE 1)				360	A
V _{SD}	Diode Forward Voltage	V _{GS} = 0 V, I _S = 25A		0.8		V
T _{RR}	Reverse recovery time	V _{DD} = 20 V, I _D = 20 A, di/dt = 100 A/μS		44		nS
Q _{RR}	Reverse recovery charge			45		nC
I _{RRM}	Peak Reverse Recovery Current			1.6		A

Electrical Characteristics Diagrams

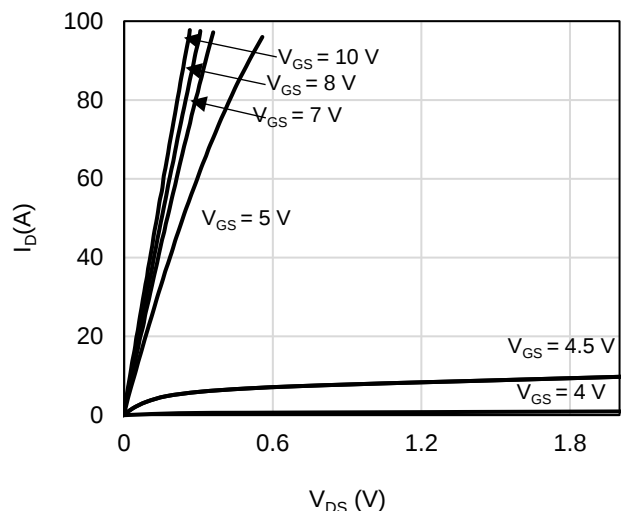


Figure 1: On-Region Characteristics

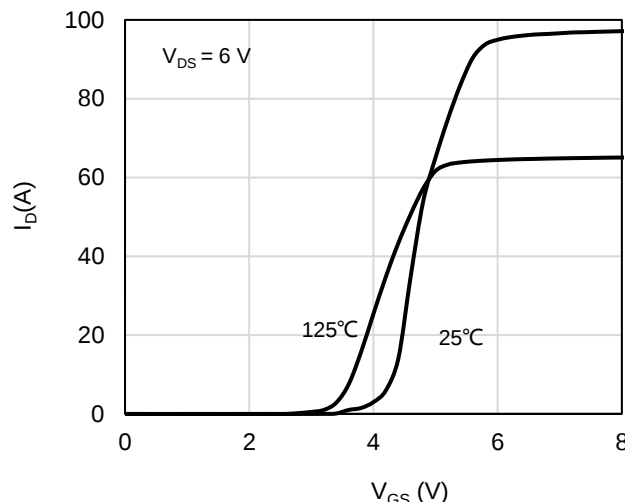


Figure 2: Transfer Characteristics

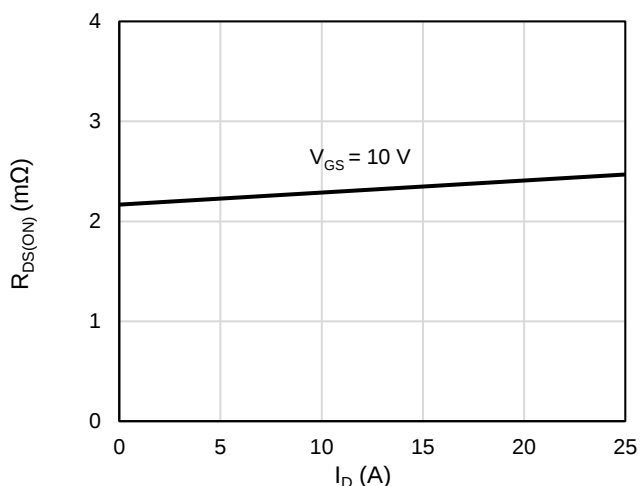


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

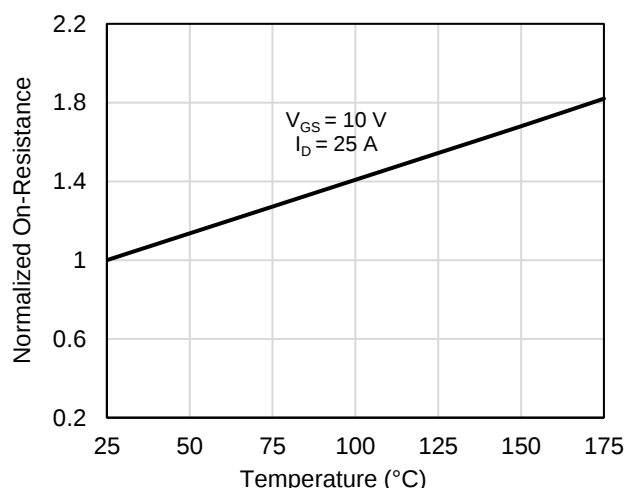


Figure 4: On-Resistance vs. Junction Temperature

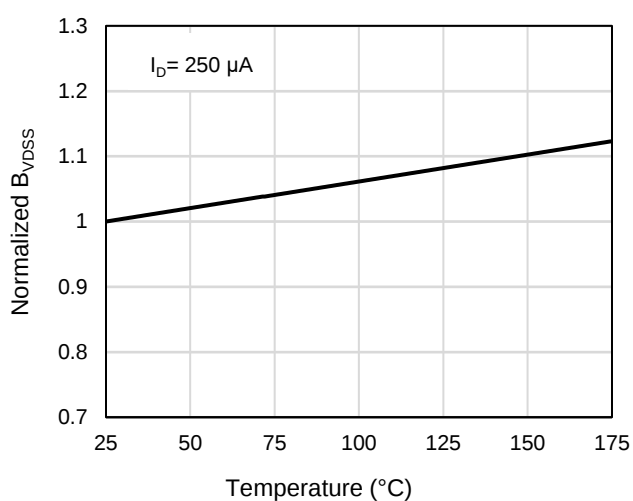


Figure 5: Breakdown Voltage vs. Junction Temperature

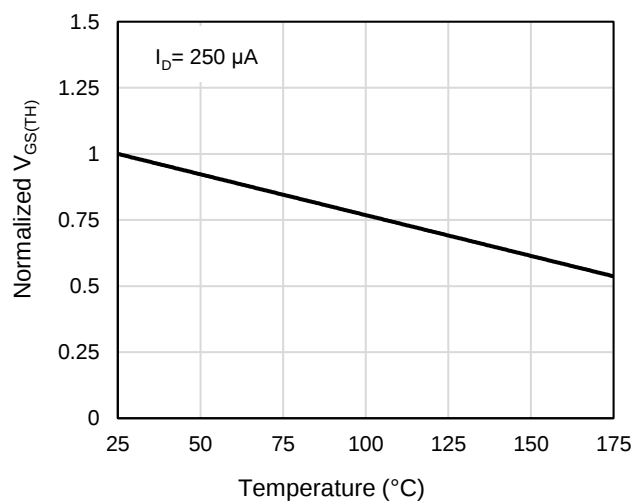


Figure 6: Threshold Voltage vs. Junction Temperature

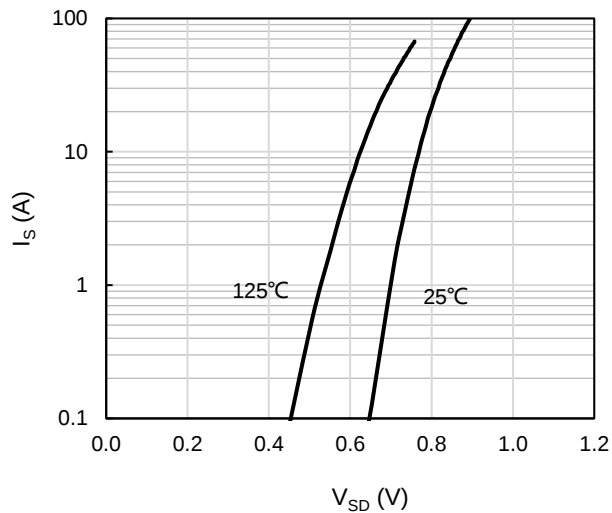


Figure 7: Body-Diode Characteristics

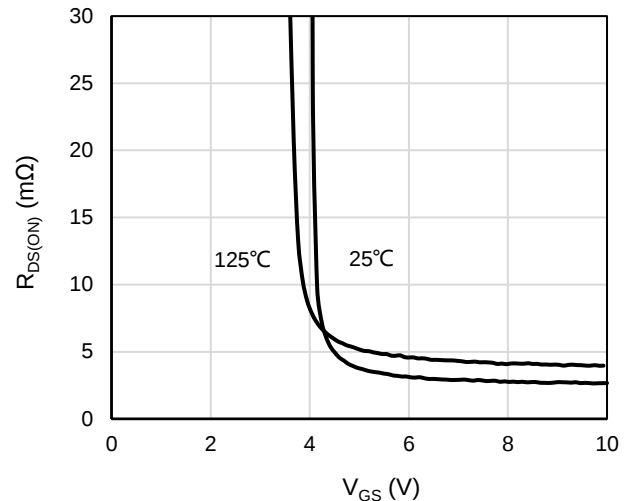


Figure 8: On-Resistance vs. Gate-Source Voltage

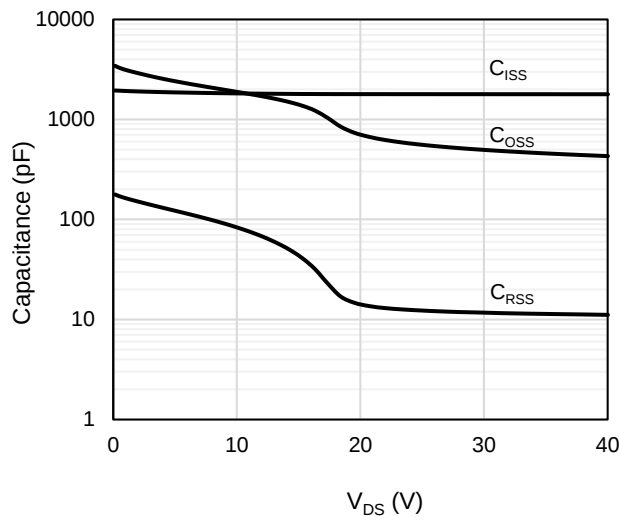


Figure 9: Capacitance Characteristics

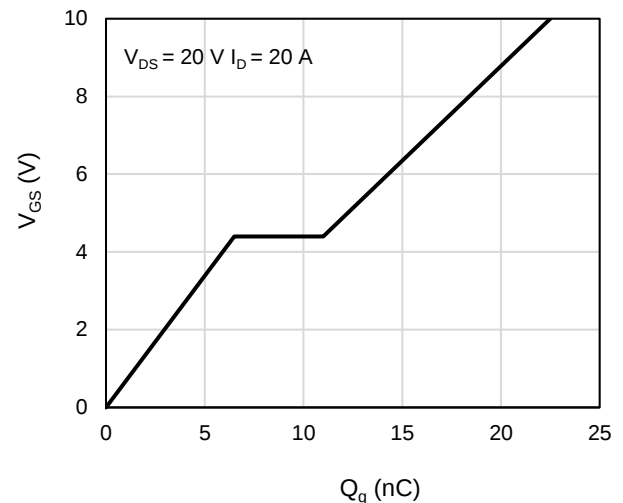


Figure 10: Gate-Charge Characteristics

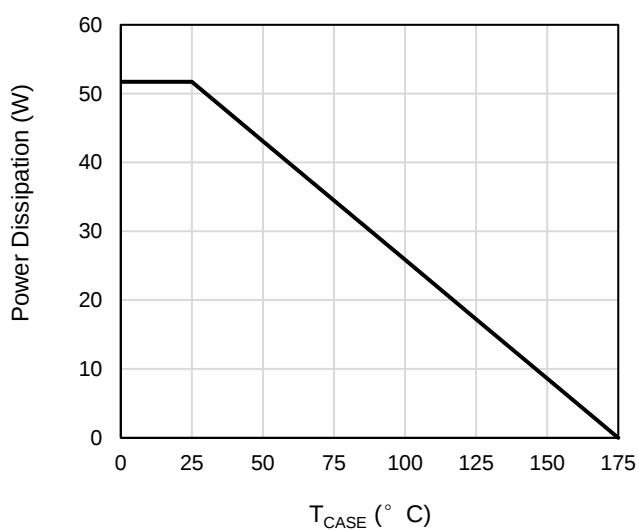


Figure 11: Power De-rating

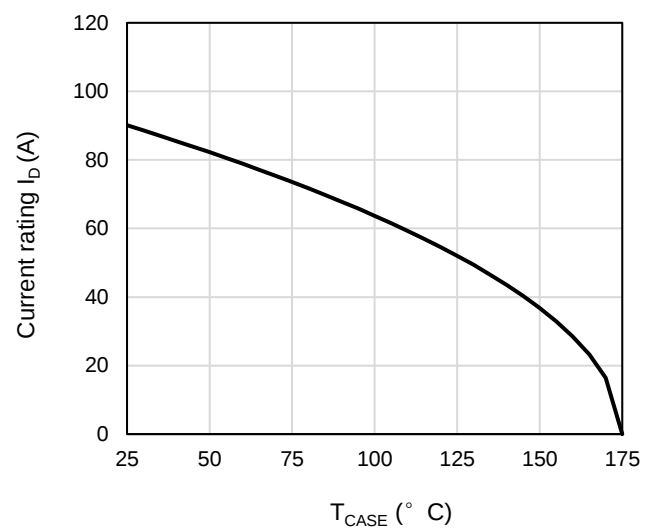
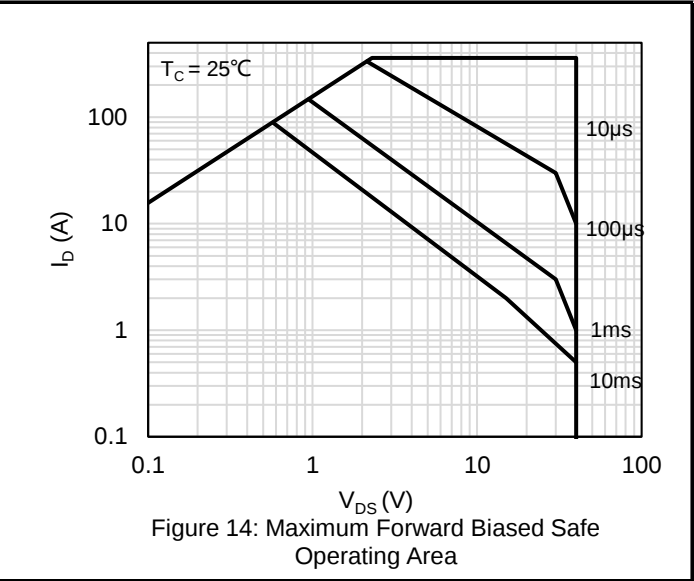
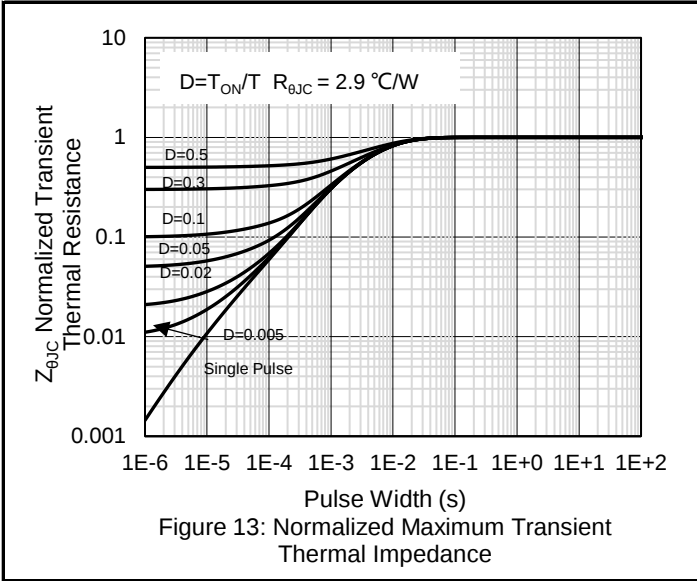
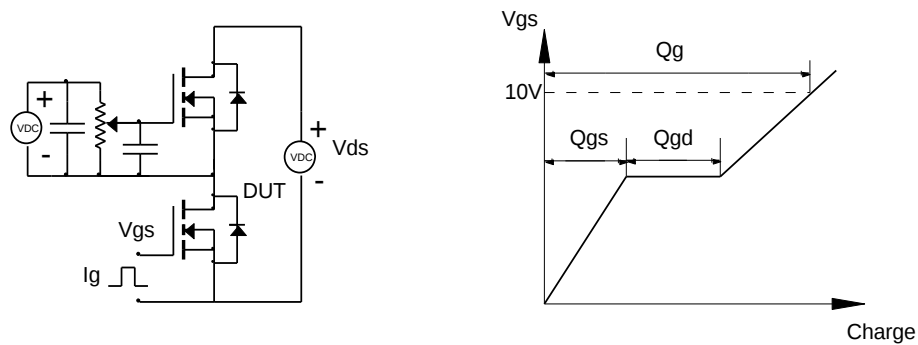


Figure 12: Current De-rating

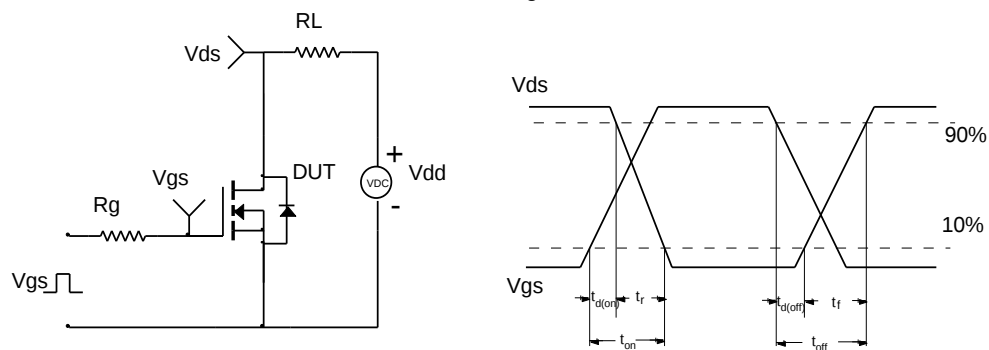


Test Circuit and Waveform

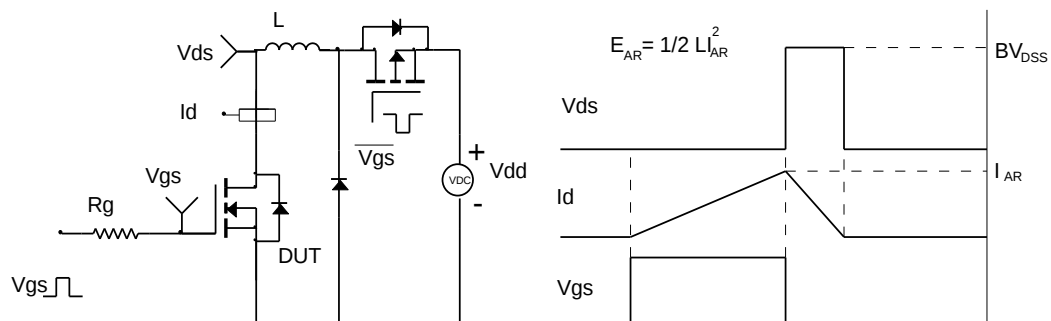
Gate Charge Test Circuit & Waveform



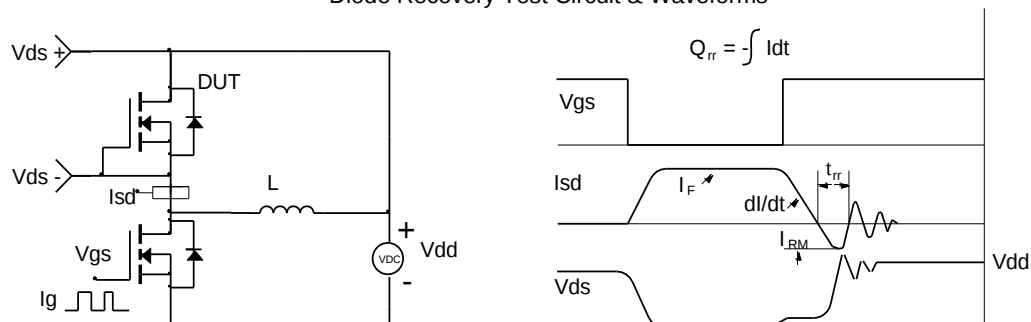
Resistive Switching Test Circuit & Waveforms



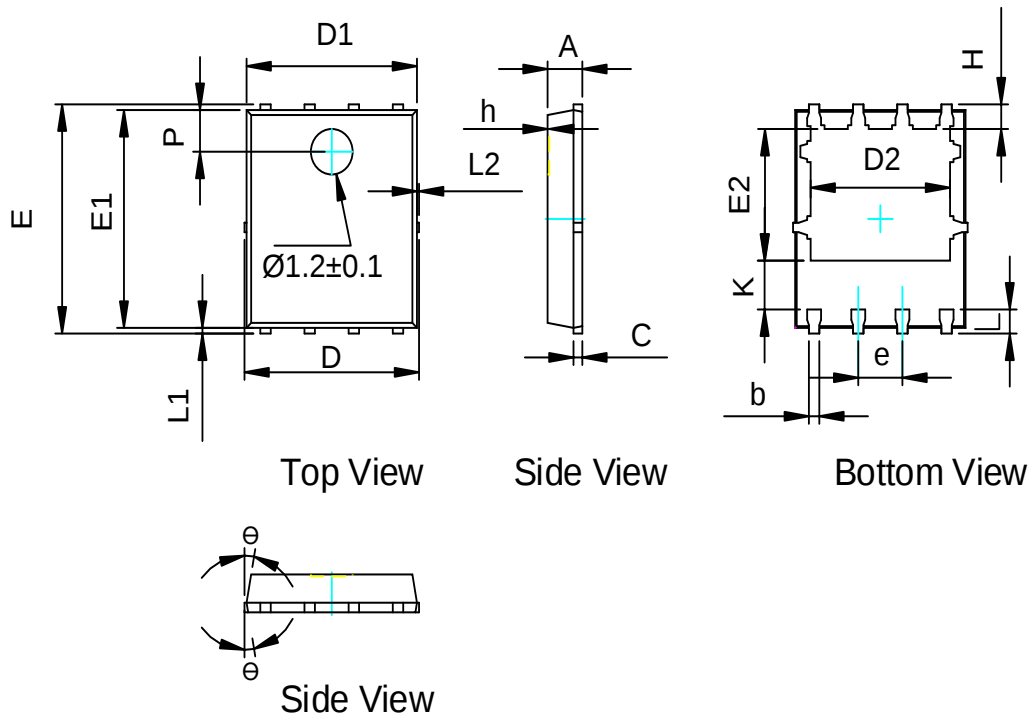
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



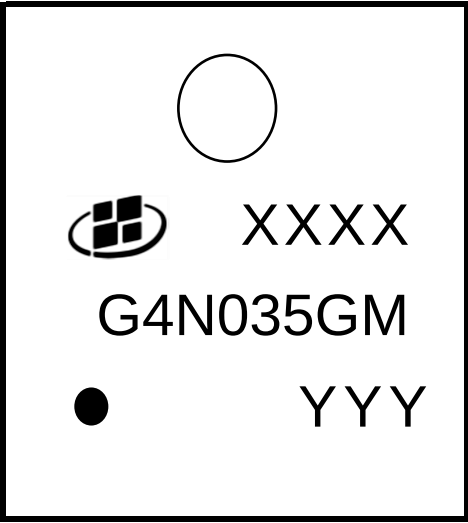
Package Outlines



SYMBOL	MIN	NOM	MAX
A	0.90	1.00	1.10
b	0.20	0.30	0.40
c	0.21	0.25	0.34
D	—	—	5.10
D1	4.80	4.90	5.00
D2	3.91	4.01	4.11
e	1.27 BSC		
E	5.90	6.00	6.10
E1	5.65	5.75	5.85
E2	3.375	3.475	3.575
H	0.55	0.65	0.75
h	—	—	0.05
K	1.20	—	—
L	0.55	0.65	0.75
L1	0.05	0.15	0.25
L2	—	—	0.12
θ	8°	10°	12°
P	1.00	1.10	1.20

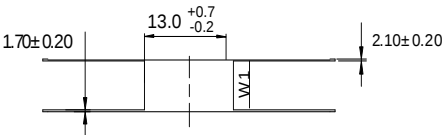
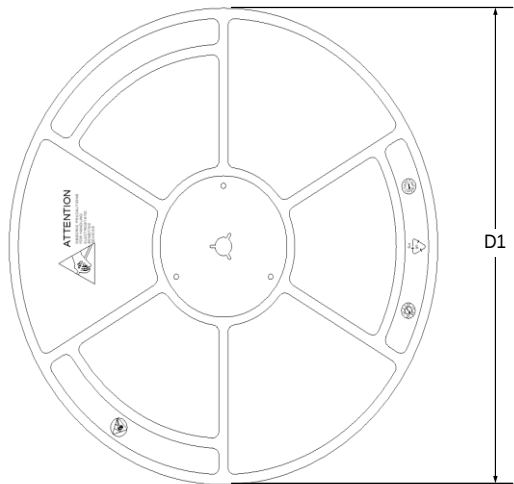
COMMON DIMENSIONS: (UNITS OF MEASURE = MILLIMETER)

Marking Information

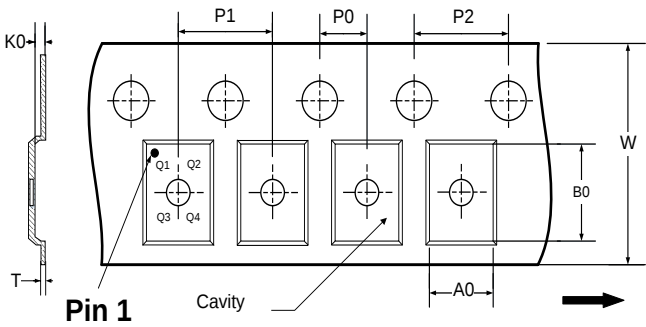


Note:
G4N035GM = Product Name Code
XXXX = Date code
YYY
Contact ALKAIDSEMI sales for detail information

REEL DIMENSIONS



TAPE DIMENSIONS



A0: Dimension designed to accommodate the component width
B0: Dimension designed to accommodate the component length
K0: Dimension designed to accommodate the component thickness
W: Overall width of the carrier tape
P0: Pitch between successive cavity centers and sprocket hole
P1: Pitch between successive cavity centers
P2: Pitch between sprocket hole
T: Tape material thickness
D1: Reel Diameter
W1: Reel Width

DIMENSIONS										(Unit: mm)
Reel	D1	W1								Material
	330	12.5								Hips
Tape	P0	P1	P2	W	A0	B0	K0	T	Pin 1 Quadrant	Material
	4	8	2	12	6.3	5.3	1.2	0.25	Q1	PC
All dimensions are nominal										

Revision History

Revision	Release Date	Remark
Rev.1.0	2022/12/20	Initial Release

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.